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Vishay Semiconductors

RoHS

COMPLIANT

HALOGEN FREE

<u>GREE</u>N

High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMY2940 series are infrared, 940 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

FEATURES

Package type: surface-mountPackage form: GW, RGW



• Peak wavelength: λ_p = 940 nm

· High reliability

· High radiant power

Very high radiant intensity

• Angle of half intensity: $\varphi = \pm 10^{\circ}$

· Suitable for high pulse current operation

· Terminal configurations: gullwing or reverse gullwing

Package matches with detector VEMD2000X01 series

• Floor life: 4 weeks, MSL 2a, according to J-STD-020

 Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- · Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors
- · Smart metering

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (°)	$\lambda_{\mathbf{P}}$ (nm)	t _r (ns)
VSMY2940RG	145	± 10	940	10
VSMY2940G	145	± 10	940	10

Note

· Test conditions see table "Basic Characteristics"

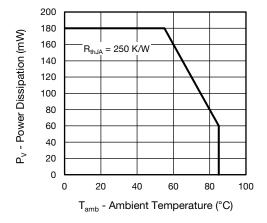
ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY2940RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMY2940G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	

Note

• MOQ: minimum order quantity



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	5	V
Forward current		I _F	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	200	mA
Surge forward current	t _p = 100 μs	I _{FSM}	1	Α
Power dissipation		P _V	180	mW
Junction temperature		Tj	100	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	According to Fig. 10, J-STD-020	T _{sd}	260	°C
Thermal resistance junction to ambient	J-STD-051, soldered on PCB	R _{thJA}	250	K/W



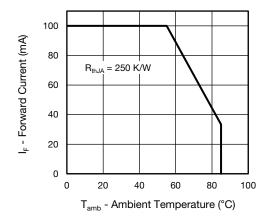


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Famuurd valtage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V_{F}	-	1.4	1.8	V
Forward voltage	$I_F = 1 \text{ A}, t_p = 100 \ \mu\text{s}$	V _F	-	2.5	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-0.7	-	mV/K
Reverse current		I _R	Not designed for reverse operation μA		μA	
Junction capacitance	$V_R = 0 \text{ V, f} = 1 \text{ MHz, E} = 0 \text{ mW/cm}^2$	CJ	-	55	-	pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	75	145	215	mW/sr
nation intensity	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	l _e	-	1000	-	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	φ _e	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	TΚφ _e	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 10	-	0
Peak wavelength	I _F = 100 mA	λ_{p}	920	940	960	nm
Spectral bandwidth	I _F = 100 mA	Δλ	-	50	-	nm
Temperature coefficient of λ_p	I _F = 100 mA	$TK\lambda_p$	-	0.25	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	10	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	10	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

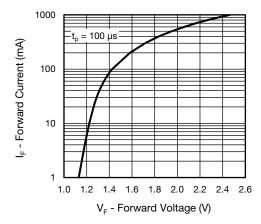


Fig. 3 - Forward Current vs. Forward Voltage

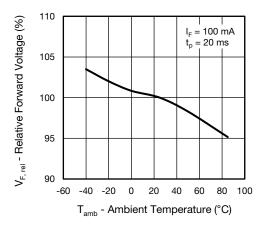


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

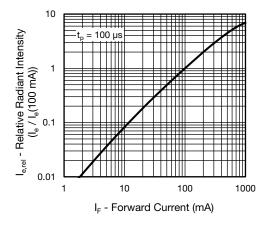


Fig. 5 - Relative Radiant Intensity vs. Forward Current

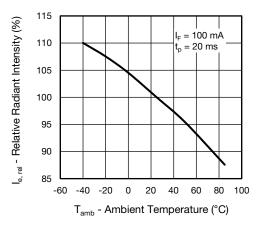


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

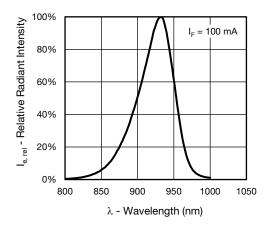


Fig. 7 - Relative Radiant Intensity vs. Wavelength

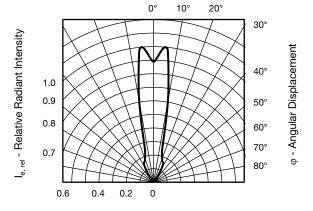


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

VSMY2940RG, VSMY2940G

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SOLDER PROFILE

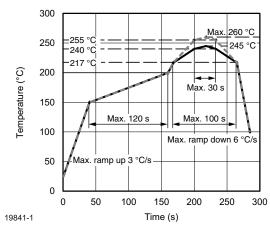


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions: T_{amb} < 30 °C, RH < 60 %

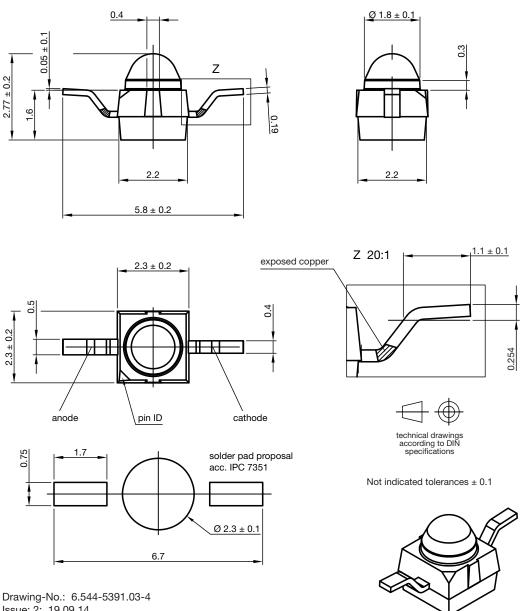
Moisture sensitivity level 2a, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

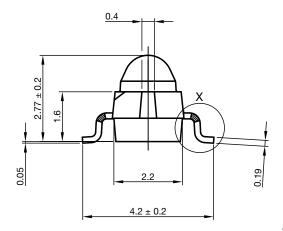
ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

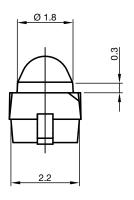
PACKAGE DIMENSIONS in millimeters: VSMY2940RG

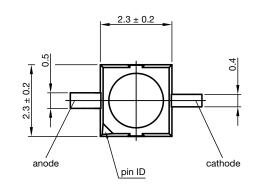


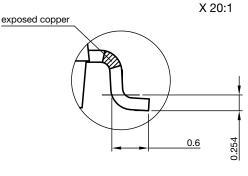
Issue: 2; 19.09.14

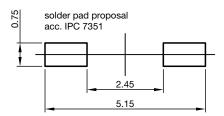
PACKAGE DIMENSIONS in millimeters: VSMY2940G





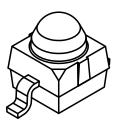








Not indicated tolerances ± 0.1

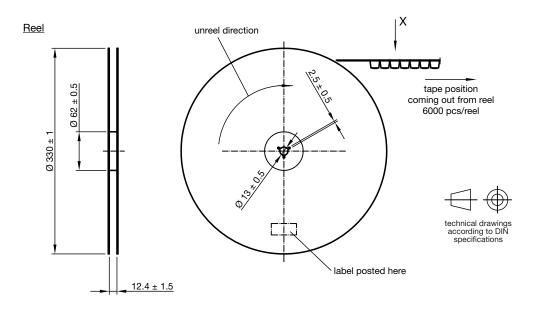


Drawing-No.: 6.544-5383.03-4

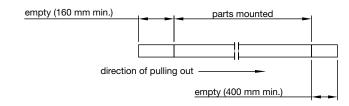
Issue: 2; 19.09.14



TAPING AND REEL DIMENSIONS in millimeters: VSMY2940RG



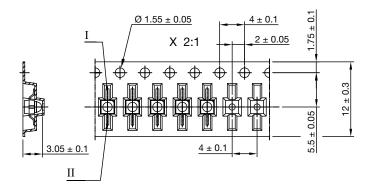
Leader and trailer tape



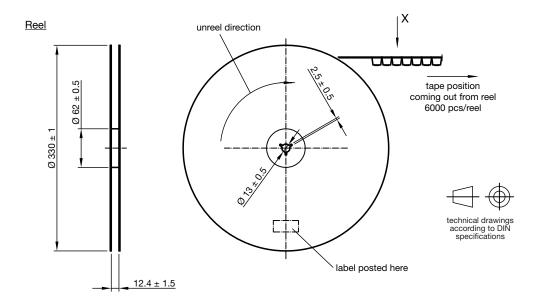
Terminal position in tape

Device	Lead I	Lead II
VEMT2000	Collector	Emitter
VEMT2500	Collector	Emiller
VEMD2000		
VEMD2500		
VSMB2000	Cathode	Anode
VSMG2000		
VSMF2890RG		
VSMY2850RG	Anode	Cathode
VSMY2940RG	Anoue	Califode

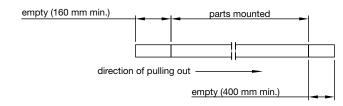
Drawing-No.: 9.800-5100.01-4 Issue: 4; 19.09.14



TAPING AND REEL DIMENSIONS in millimeters: VSMY2940G

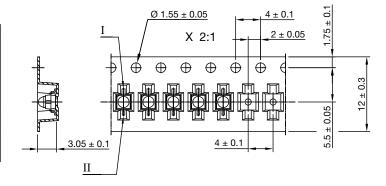


Leader and trailer tape



Terminal position in tape

Device	Lead I	Lead II	
VSMB2020			
VSMG2020			
VEMD2020	Cathode	Anode	
VEMD2520			
VSMF2890G			
VEMT2020	Collector	Emitter	
VEMT2520	Collector	Emiller	
VSMY2850G	Anode	Cathode	
VSMY2940G	Anoue	Califode	



Drawing-No.: 9.800-5091.01-4

Issue: 5; 19.09.14



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